

Statement of Compliance

Requested Part

CRG1206F110R (Part 1 of 1)	
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emptions s or Ceramic Elec. Comps.	
e	

This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.

EU ELV Directive: 2000/53/EC	Compliant with Exemptions 10(a) - Lead in certain electronic components.
China RoHS 2 Directive: MIIT Order No 32, 2016	Bestricted Materials Above Threshold
EU REACH Regulation: (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2023 (233) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content:	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability Code:	Reflow solder capable to 260°C

TE Connectivity Corporation

1050 Westlakes Drive

Berwyn, PA 19312

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Restricted Materials Above Threshold

08 June 2023

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中国电子电气产品中有害物质的名称及含量

China EEP Hazardous Substance Information

部件名称	有害物质						
(Component Name)	Hazardous Substance						
1623408-1	铅	汞	福	六价铬	多溴联苯	多溴二苯醚	
	(Pb)	(Hg)	(Cd)	(Cr6)	(PBB)	(PBDE)	
电阻器和电感器	x	0	0	0	0	0	
(Resistors and Inductors)							
O: 表示该有害物质在 Indicates that the o below the relevant	concentration c	of the hazardo	us substance ir				
X: 表示该有害物质至 Indicates that the o part is above the r	concentration c	of the hazardo	us substance ir	n at least one			
电	子电气产品的理	不保使用期限依	太据SJ/T 11388	3标准的规定确	定。		

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